

FORM PTO-1595
1-31-92

RECORDATION F
PATENT

08-13-2004

Department of Commerce
Patent and Trademark Office
Docket No. 05823.0264
Customer Number: 22,852

To the Honorable Commissioner of Patents and Trademarks
Please record the attached original documents or copy thereof.

102812979

SERVICES

10/493410

1. Name of conveying party(ies):
1) Tae Woong LEE
2) Soon Ki KIM

2. Name and address of receiving party(ies):
Name: SK CHEMICALS CO., LTD.

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

Internal Address:

3. Nature of conveyance:

Street Address: 948-1, Daechi3 -Dong, Kanynan-Ku,
135-283, Seoul, Republic of Korea

☒ Assignment ☐ Merger

City:

☐ Security Agreement ☐ Change of Name

State:

Zip Code:

☐ Other:

Additional name(s) & Address(es) attached?

Execution Date: April 21, 2004

☐ Yes

☒ No

4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application: April 21, 2004

A. Patent Application Number(s):

10493410

B. Patent Number(s):

Additional numbers attached?

☐ Yes

☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Mr. Ernest F. Chapman

6. Total number of applications and registrations involved:
1

7. Total fee (37 CFR 3.41): \$40

☒ Enclosed (Please charge deficiency to deposit account)

☐ Authorized to be charged to deposit account

Internal Address: FINNEGAN, HENDERSON, FARABOW, GARRETT
& DUNNER, L.L.P.

Street Address: 1300 I Street, N.W.

City: Washington, D.C.

State: Zip: 20005-3315

8. Deposit Account No.: 06-0916

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Ernest F. Chapman
Reg. No. 25,961

Signature

April 22, 2004

Date

Total number of pages including cover sheet, attachments and documents: 2

PATENT
REEL: 015666 FRAME: 0293

A S S I G N M E N T

WHEREAS I/WE, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

COPOLYESTER RESIN FOR SOLVENTBORNE COATING AND COATING COMPOSITION
COMPRISING THE SAME

for which I/WE executed an application for United States Letters Patent concurrently herewith or on _____
or filed an application for United States Letters Patent on _____, 20____ (Serial
No. _____); and

WHEREAS, SKCHEMICALS, a corporation of Republic of Korea, whose post office address is 948-1,
Daschis-Dong, KANYNAN-KU, 135-283 Seoul, Republic of Korea (hereinafter referred to as Assignee), is
desirous of securing the entire right, title, and interest in and to this invention, the application for United States
Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from
assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do
hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, my/our entire
right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof,
and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE
hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all
Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this
Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration,
communicate with assignee, its successors and assigns, any facts known to me/us respecting this invention and
testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers
that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and
assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do
everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection
for this invention in the United States, it being understood that any expense incident to the execution of such
papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/we have empowered in the Declaration
and Power of Attorney in this application, to insert here in parentheses (Application No. _____
filed _____) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/We have hereunto set our hand(s).

1. Full Name of Sole or First Assignor : Assignor's Signature : Date

TAE WOONG Lee : T.W. Lee : 21/4/2004
Address : _____ : Citizenship
Poong-lim APT 308-204, 1235 Kwon-seon-dong, Kwonseon-ku, Suwon-si, Kyungki-do, Republic of Korea:KR

2. Full Name of Second Assignor : Assignor's Signature : Date

SOON KI Kim : Soon Ki Kim : 21/04/2004
Address : _____ : Citizenship
Shin-dong-a APT 113-2006, 648-2 Hwaseo2-dong, Changan-ku, Suwon-si, Kyungki-do, Republic of Korea:KR

FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P.